

SUBMINIATURE SOLID STATE LAMP

Part Number: AM27EC03 High Efficiency Red

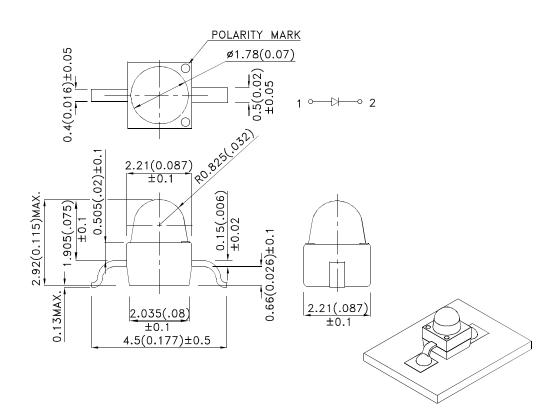
Features

- Subminiature package.
- · Gull wing.
- Long life solid state reliability.
- Low package profile.
- Package :1000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

Package Dimensions



- All dimensions are in millimeters (inches).
 Tolerance is ±0.25(0.01") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
- 5. The device has a single mounting surface. The device must be mounted according to the specifications.

SPEC NO: DSAB5748 **REV NO: V.8** DATE: APR/14/2011 PAGE: 1 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: J.Yu ERP: 1202000245

Selection Guide

Part No.	Dice Lens Type		lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
AM27EC03	High Efficiency Red (GaAsP/GaP)	Water Clear	50	100	20°

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red	627		nm	IF=20mA
λD [1]	Dominant Wavelength	High Efficiency Red	625		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	High Efficiency Red	45		nm	I=20mA
С	Capacitance	High Efficiency Red	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	High Efficiency Red	2	2.5	V	I=20mA
lR	Reverse Current	High Efficiency Red		10	uA	V _R =5V

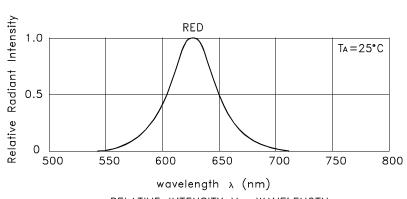
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

Parameter	High Efficiency Red	Units	
Power dissipation	75	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	160	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

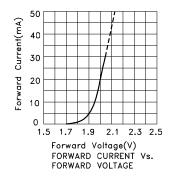
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

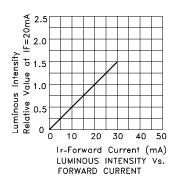
SPEC NO: DSAB5748 **REV NO: V.8** DATE: APR/14/2011 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: J.Yu ERP: 1202000245

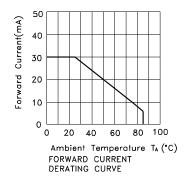


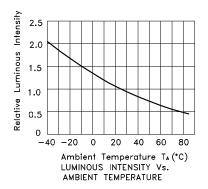
RELATIVE INTENSITY Vs. WAVELENGTH

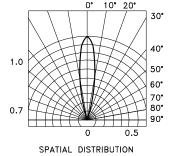
High Efficiency Red AM27EC03











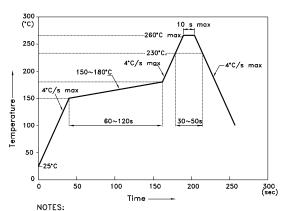
 SPEC NO: DSAB5748
 REV NO: V.8
 DATE: APR/14/2011
 PAGE: 3 OF 5

 APPROVED: WYNEC
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AM27EC03

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



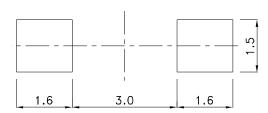
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

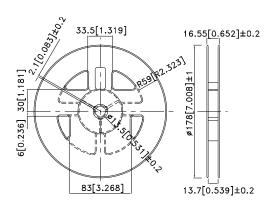
 3.Number of reflow process shall be 2 times or less.

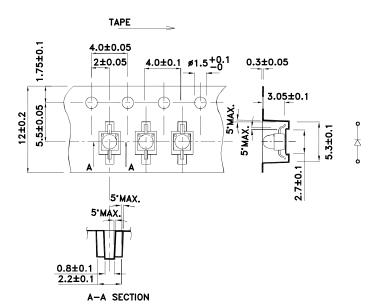
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Dimensions (Units: mm)

Reel Dimension

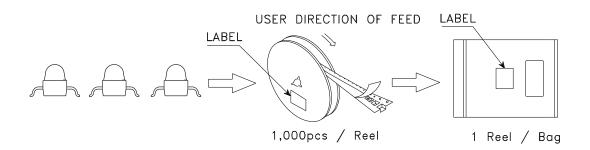


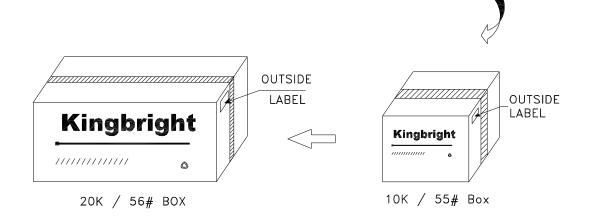


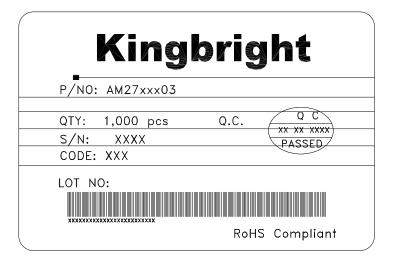
SPEC NO: DSAB5748 **REV NO: V.8** DATE: APR/14/2011 PAGE: 4 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: J.Yu ERP: 1202000245

PACKING & LABEL SPECIFICATIONS

AM27EC03







SPEC NO: DSAB5748 APPROVED: WYNEC REV NO: V.8 CHECKED: Allen Liu DATE: APR/14/2011 DRAWN: J.Yu PAGE: 5 OF 5 ERP: 1202000245